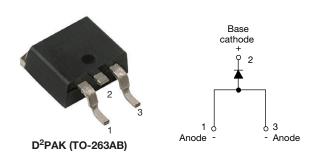


RoHS

COMPLIANT HALOGEN

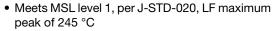
FREE

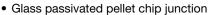
Surface Mount Fast Soft Recovery Rectifier Diode, 10 A



PRIMARY CHARACTERISTICS							
I _{F(AV)}	10 A						
V _R	600 V						
V _F at I _F	1.2 V						
I _{FSM}	140 A						
t _{rr}	50 ns						
T _J max.	150 °C						
Snap factor	0.6						
Package	D ² PAK (TO-263AB)						
Circuit configuration	Single						

FEATURES





- AEC-Q101 qualified
- Meets JESD 201 class 1A whisker test
- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Input rectification
- · On-board and off-board EV / HEV battery chargers

DESCRIPTION

The VS-10ETF06SLHM3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL CHARACTERISTICS VALUES U									
V _{RRM}		600	V						
I _{F(AV)}	Sinusoidal waveform	10	۸						
I _{FSM}		140	A						
t _{rr}	1 A, 100 A/μs	50	ns						
V _F	10 A, T _J = 25 °C	1.2	V						
TJ	Range	-40 to +150	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA						
VS-10ETF06SLHM3	600	700	2.5						

ABSOLUTE MAXIMUM RATINGS								
PARAMETER SYMBOL TEST CONDITIONS VALUES UNITS								
Maximum average forward current	I _{F(AV)}	T _C = 128 °C, 180° conduction half sine wave	10					
Maximum peak one cycle	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied	115	Α				
non-repetitive surge current		10 ms sine pulse, no voltage reapplied	140					
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied	66	A ² s				
Maximum I-t for fusing		10 ms sine pulse, no voltage reapplied	94 A ² S					
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied	940	A ² √s				

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ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
Maximum forward voltage drop	V_{FM}	10 A, T _J = 25 °C	1.2	V				
Forward slope resistance	r _t	T _{.1} = 150 °C	12.7	$m\Omega$				
Threshold voltage	V _{F(TO)}	1) = 130 0	1.25	V				
Maximum reverse leakage current	1	T _J = 25 °C	V rated V	0.1	mA			
iviaximum reverse leakage current	I _{RM}	T _J = 150 °C	V_R = rated V_{RRM}	2.5	IIIA			

RECOVERY CHARACTERISTICS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	†				
Reverse recovery time	t _{rr}	I _F at 10 A _{pk}	200	ns	I _{FM} +				
Reverse recovery current	I _{rr}	25 A/µs	2.75	А	, m				
Reverse recovery charge	Q _{rr}	25 °C	0.32	μC	dir/Q _{rr}				
Snap factor	S		0.6		I _{RM(REC)}				

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C				
Maximum thermal resistance junction to case	R _{thJC}	DC operation	1.5	°C/W				
Maximum thermal resistance junction to ambient (PCB mount)	R _{thJA} ⁽¹⁾		40	C/VV				
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
Marking device		Case style D ² PAK (TO-263AB)	10ETF	06SH				

Note

 $^{^{(1)}}$ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μ m) copper 40 °C/W.

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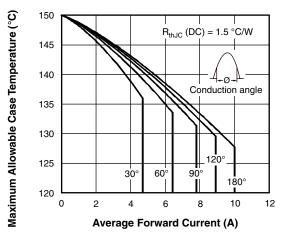


Fig. 1 - Current Rating Characteristics

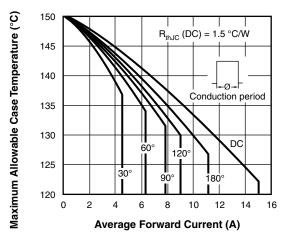


Fig. 2 - Current Rating Characteristics

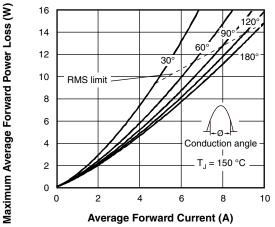


Fig. 3 - Forward Power Loss Characteristics

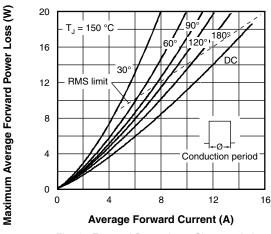


Fig. 4 - Forward Power Loss Characteristics

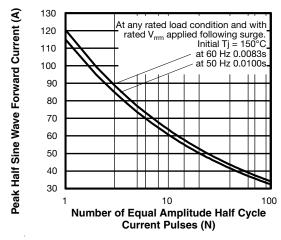


Fig. 5 - Maximum Non-Repetitive Surge Current

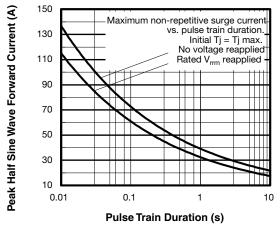


Fig. 6 - Maximum Non-Repetitive Surge Current

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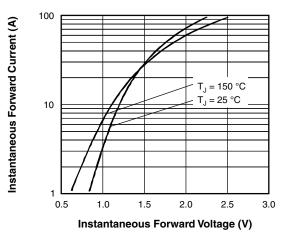


Fig. 7 - Forward Voltage Drop Characteristics

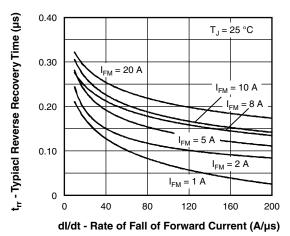


Fig. 8 - Recovery Time Characteristics, $T_J = 25$ °C

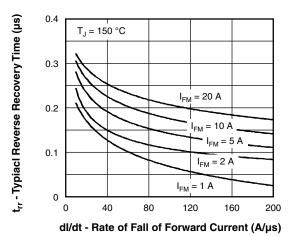


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

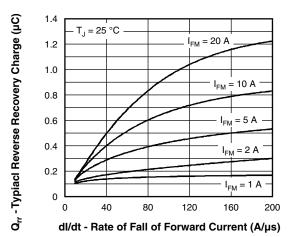


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

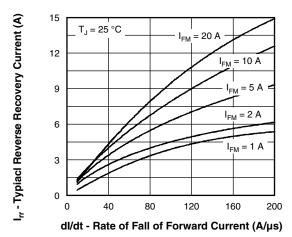


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

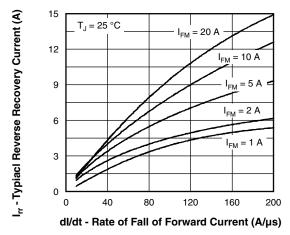


Fig. 12 - Recovery Current Characteristics, $T_J = 25$ °C



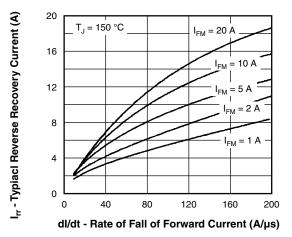


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

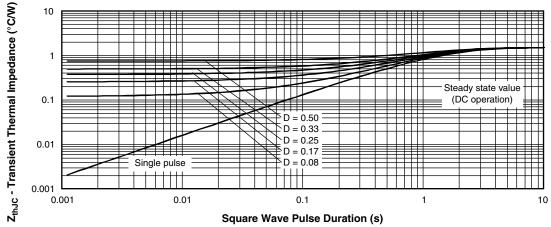
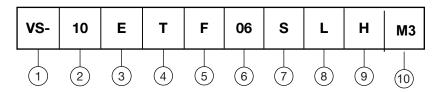


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (10 = 10 A)

Circuit configuration:

E = single

4 - Package:

 $T = D^2PAK (TO-263AB)$

5 - Type of silicon:

F = fast soft recovery rectifier

6 - Voltage code x 100 = V_{RRM} ----- 06 = 600 V

7 - S = surface mountable

L = tape and reel (left oriented), for different orientation,

contact factory

9 - H = AEC-Q101 qualified 10 - Environmental digit:

M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

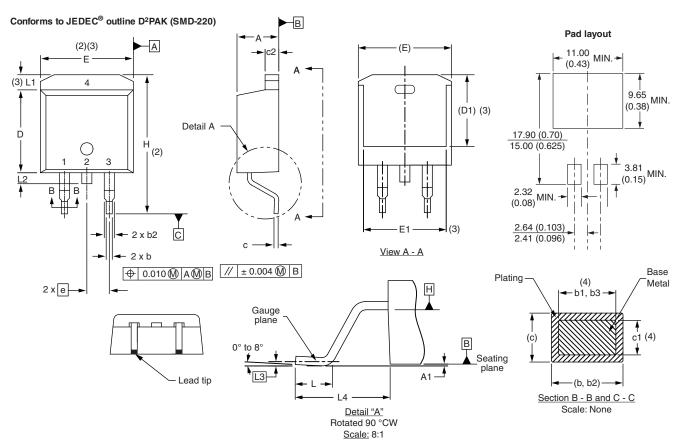
ORDERING INFORMATION (Example)								
PREFERRED P/N	PACKAGING DESCRIPTION							
VS-10ETF06SLHM3	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95046</u>						
Part marking information	www.vishay.com/doc?95444					
Packaging information	www.vishay.com/doc?96317					



D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	ETERS	INC	HES	NOTES	NOTES		OTES SYMBOL		MILLIMETERS		INCHES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3	
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3	
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3	
b1	0.51	0.89	0.020	0.035	4		е	2.54 BSC 0.100 BSC		BSC			
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625		
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110		
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3	
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070		
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 08-Jul-15 1 Document Number: 95046

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